

S/N 10/823,314

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant:	NEO C. PENG ET AL.	Examiner: Samuel M Heinrich
Serial No.:	10/823,314	Group Art Unit: 1725
Filed:	April 13, 2004	Docket: 303.772US2
Title:	WAFER DICING DEVICE AND METHOD	

RESPONSE TO RESTRICTION REQUIREMENT

MS Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

In response to the Restriction Requirement mailed May 29, 2007, Applicant submits the following.